

15 July 2024

**Product data sheet** 

# 1. General description

High power density, hyperfast switching time dual recovery rectifier in common cathode configuration with high-efficiency planar technology, encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

Reverse voltage: V<sub>R</sub> ≤ 200 V

Forward current: I<sub>F</sub> ≤ 4 A (per diode)

Switching time: t<sub>rr</sub> ≤ 30 ns
Pt doped life time control

Low inductance

Power and flat lead SMD plastic package

Package height typical 0.95 mm

High power capability due to clip-bond technology

Planar die design

# 3. Applications

- · General-purpose rectification
- · Hyperfast switching
- Solenoid control
- Piezo injection
- Freewheeling applications

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Per diode (unle	Per diode (unless otherwise specified)							
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 155 °C		-	-	4	А	
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	200	V	
$V_{RRM}$	repetitive peak reverse voltage			-	-	200	V	
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 4 A; T <sub>j</sub> = 25 °C	[1]	-	860	930	mV	
		I <sub>F</sub> = 4 A; T <sub>j</sub> = 125 °C	[1]	-	710	810	mV	
I <sub>R</sub>	reverse current	V <sub>R</sub> = 200 V; T <sub>j</sub> = 25 °C	[1]	-	-	1	μΑ	
		V <sub>R</sub> = 200 V; T <sub>j</sub> = 125 °C	[1]	-	2	40	μΑ	

[1] Very short pulse, in order to maintain a stable junction temperature.



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)		CC
2	A2	anode (diode 2)		
3	CC	common cathode	3 CFP15B (SOT1289B)	A1 A2 aaa-030081

# 6. Ordering information

#### **Table 3. Ordering information**

Type number			
	Name	Description	Version
PNE20080CPE		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	<u>SOT1289B</u>

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PNE20080CPE	200E
	008C

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC60134)

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode (u	nless otherwise specified)					
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	200	V
$V_{RRM}$	repetitive peak reverse voltage			-	200	V
$V_{R(RMS)lim}$	limiting RMS reverse voltage			-	140	V
l <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> ≤ 150 °C		-	5.6	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 155 °C		-	4	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; single half sine wave (applied at rated load condition); $T_{j(init)}$ = 25 °C		-	90	А
		$t_p$ = 8.3 ms; single half sine wave (applied at rated load condition); per device; $T_{j(\text{init})}$ = 25 °C		-	170	A
Per device, o	one diode loaded					
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
T <sub>j</sub>	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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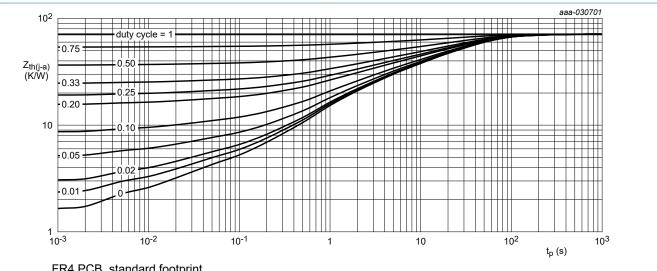
<sup>[2]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

# 9. Thermal characteristics

**Table 6. Thermal characteristics** 

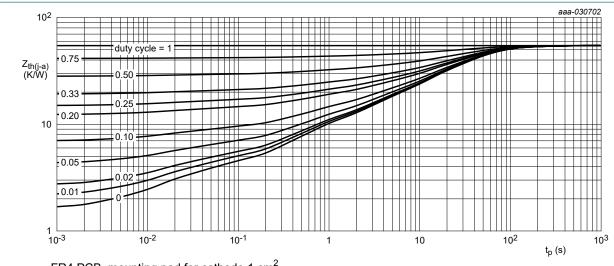
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per device, on	e diode loaded						
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1]	-	-	90	K/W
junction to ambient	junction to ambient		[2]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	7	K/W

- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- Soldering point of cathode tab.



FR4 PCB, standard footprint

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values Fig. 2.

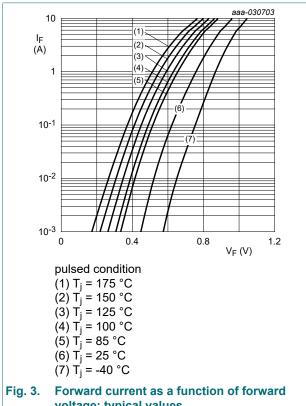
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# 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diode (ı	unless otherwise specified	)					
$V_{(BR)R}$	reverse breakdown voltage	I <sub>R</sub> = 100 μA; T <sub>j</sub> = 25 °C	[1]	200	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 4 A; T <sub>j</sub> = 25 °C	[1]	-	860	930	mV
		I <sub>F</sub> = 4 A; T <sub>j</sub> = 125 °C	[1]	-	710	810	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 200 V; T <sub>j</sub> = 25 °C	[1]	-	-	1	μΑ
		V <sub>R</sub> = 200 V; T <sub>j</sub> = 125 °C	[1]	-	2	40	μΑ
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 4 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	60	-	pF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}$ ; $I_R = 1 \text{ A}$ ; $I_{R(meas)} = 0.25 \text{ A}$ ; $I_{j} = 25 \text{ °C}$		-	12	30	ns
	reverse recovery time ramp recovery	$dI_F/dt = 50 \text{ A/}\mu\text{s}; I_F = 1 \text{ A}; V_R = 30 \text{ V};$ $T_j = 25 \text{ °C}$		-	19	-	ns
	reverse recovery time	$dI_F/dt = 100 A/\mu s; I_F = 1 A; V_R = 30 V;$		-	15	-	ns
I <sub>RM</sub>	peak reverse recovery current	T <sub>j</sub> = 25 °C		-	1	-	A
Q <sub>rr</sub>	reverse recovery charge			-	9	-	nC
$V_{FRM}$	peak forward recovery voltage	$I_F = 1 \text{ A}; dI_F/dt = 50 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$		-	785	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



voltage; typical values

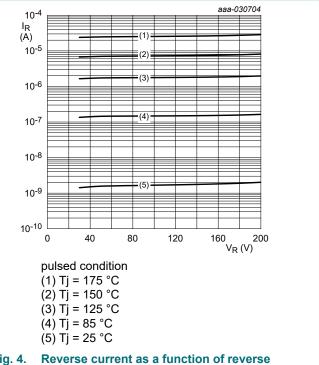


Fig. 4. voltage; typical values

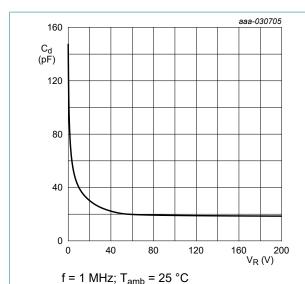
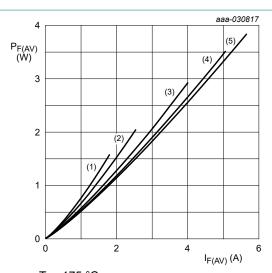
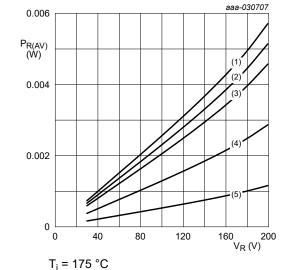


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



 $T_j = 175 \,^{\circ}\text{C}$ (1)  $\delta = 0.1$ (2)  $\delta = 0.2$ (3)  $\delta = 0.5$ (4)  $\delta = 0.8$ (5)  $\delta = 1$ ; DC

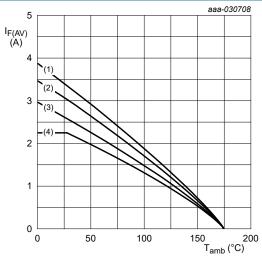
Fig. 6. Average forward power dissipation as a function of average forward current; typical values



 $f_j = 175$  C  $f_j$ 

 $(5) \delta = 0.2$ 

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

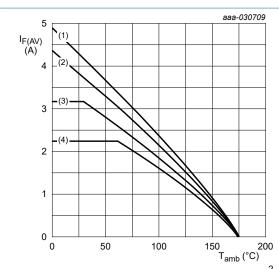
 $T_j = 175 \,^{\circ}\text{C}$ (1)  $\delta = 1$ ; DC (2)  $\delta = 0.5$ ; f =

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

 $T_i = 175 \,{}^{\circ}\text{C}$ 

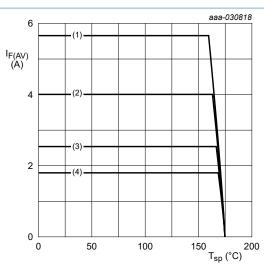
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



 $T_i = 175 \,{}^{\circ}\text{C}$ 

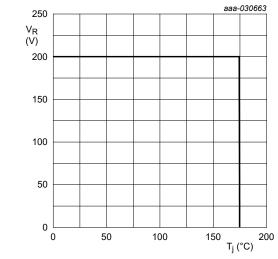
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

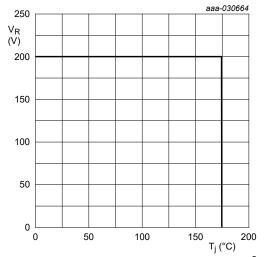
 $(4) \delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values



FR4 PCB, standard footprint  $R_{th} = 90 \text{ K/W}$ 

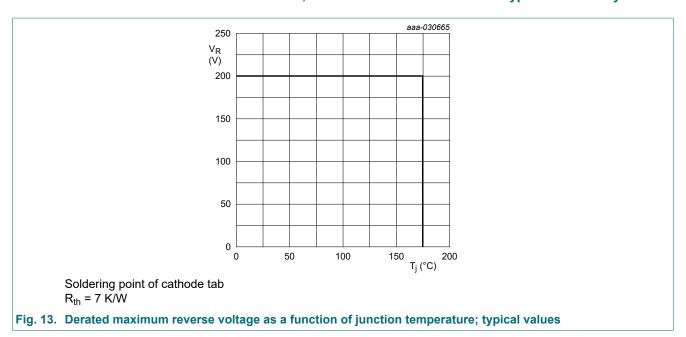
of junction temperature; typical values



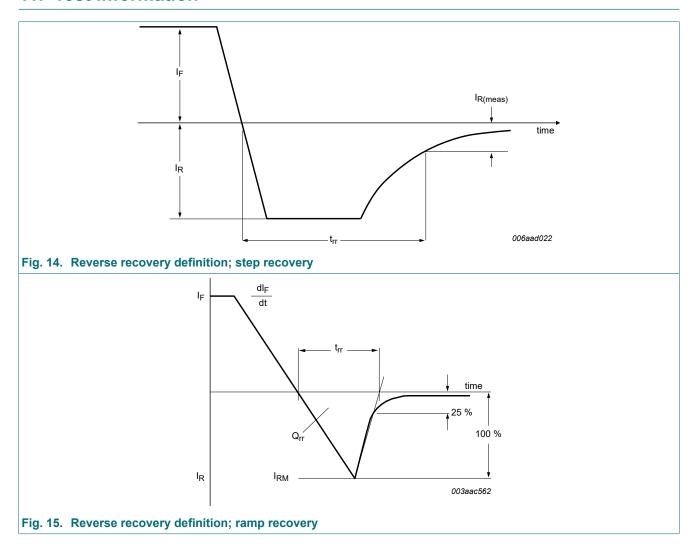
FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>  $R_{th} = 70 \text{ K/W}$ 

Fig. 11. Derated maximum reverse voltage as a function | Fig. 12. Derated maximum reverse voltage as a function of junction temperature; typical values

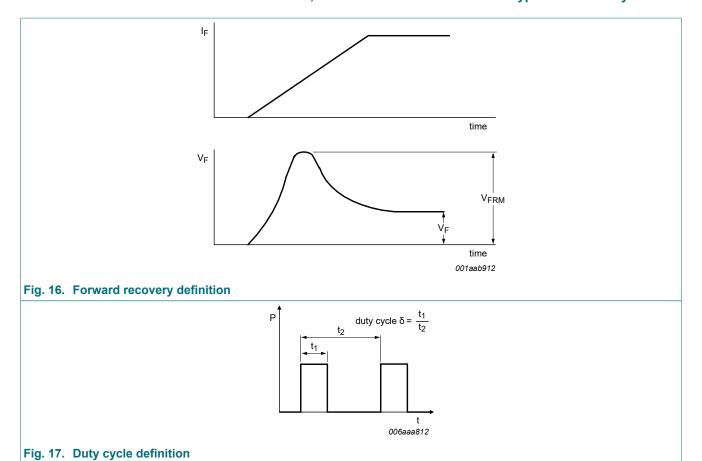
### 200 V, 2 x 4 A dual common cathode hyperfast recovery rectifier



# 11. Test information



### 200 V, 2 x 4 A dual common cathode hyperfast recovery rectifier



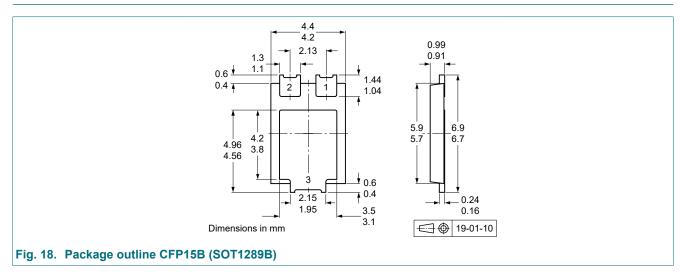
The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$ 

with I<sub>RMS</sub> defined as RMS current.

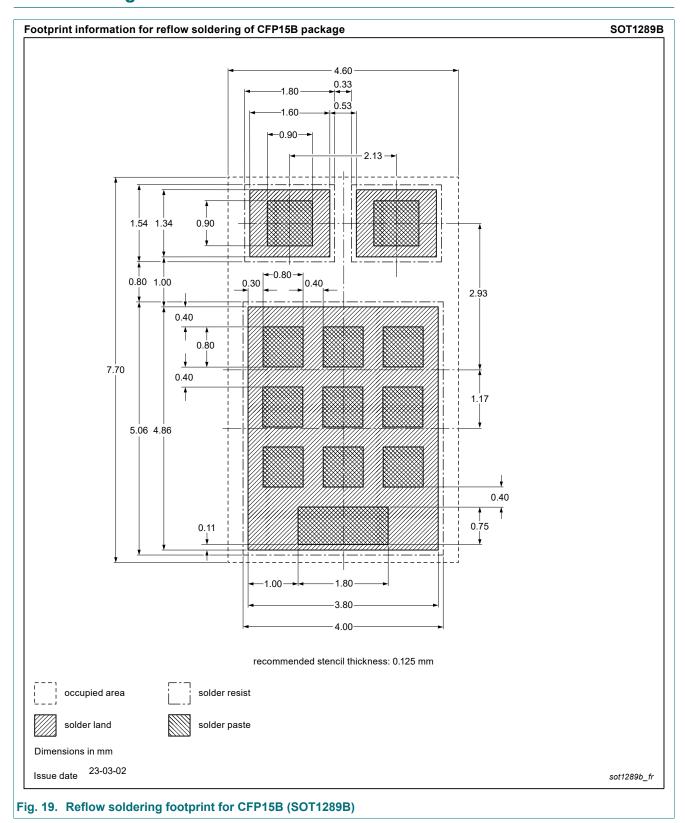
# 12. Package outline



PNE20080CPE

200 V, 2 x 4 A dual common cathode hyperfast recovery rectifier

# 13. Soldering



### 200 V, 2 x 4 A dual common cathode hyperfast recovery rectifier

# 14. Revision history

#### Table 8. Revision history

Table 6. Revision mistory				
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PNE20080CPE v.5	20240715	Product data sheet	-	PNE20080CPE v.4
Modifications:	Reflow solderin	g footprint: Stencil design	for solder paste	printing changed.
PNE20080CPE v.4	20230401	Product data sheet	-	PNE20080CPE v.3
PNE20080CPE v.3	20210909	Product data sheet	-	PNE20080CPE v.2
PNE20080CPE v.2	20200214	Product data sheet	-	PNE20080CPE v.1
PNE20080CPE v.1	20200127	Product data sheet	-	-

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# 15. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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### 200 V, 2 x 4 A dual common cathode hyperfast recovery rectifier

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